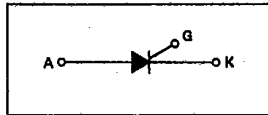


## Silicon Controlled Rectifiers Reverse Blocking Triode Thyristors

... fast switching, high-voltage Silicon Controlled Rectifiers especially designed for pulse modulator applications in radar and other similar equipment.

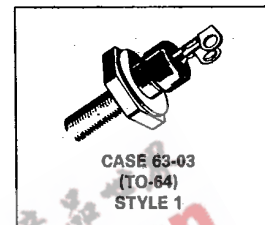
- High-Voltage:  $V_{DRM} = 300$  to 800 Volts
- Turn-On Times: in Nanosecond Range
- Repetitive Pulse Current to 100 Amps
- Stable Switching Characteristics Over an Operating Temperature Range From  $-65$  to  $+105^{\circ}\text{C}$
- Pulse Repetition Rates as High as 10,000 pps



**MCR649AP1-10**  
(See 2N2574)

**MCR729-5**  
thru  
**MCR729-10**

SCRs  
5 AMPERES RMS  
300 thru 800 VOLTS



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**MAXIMUM RATINGS** ( $T_J = 105^{\circ}\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Forward Blocking Voltage, Note 1 MCR729-5	$V_{DRM}$	300	Volts
-6		400	
-7		500	
-8		600	
-9		700	
-10		800	
Peak Repetitive Reverse Blocking Voltage, Note 1	$V_{RRM}$	50	Volts
Forward Current RMS	$I_T(\text{RMS})$	5	Amps
Average Forward Power	$P_F(\text{AV})$	5	Watts
Peak Repetitive On-State Control ( $PW = 10 \mu\text{s}$ )	$I_{TRM}$	100	Amps
Peak Forward Gate Power	$P_{GFM}$	20	Watts
Average Forward Gate Power	$P_{GF(\text{AV})}$	1	Watt
Peak Forward Gate Current	$I_{GFM}$	5	Amps
Peak Forward Gate Voltage	$V_{GFM}$	10	Volts
Peak Reverse Gate Voltage	$V_{GRM}$	10	Volts
Operating Junction Temperature Range	$T_J$	$-65$ to $+105$	$^{\circ}\text{C}$
Storage Temperature Range	$T_{\text{stg}}$	$-65$ to $+150$	$^{\circ}\text{C}$
Stud Torque		15	in. lb.

Note 1. Ratings apply for zero or negative gate voltages. Devices shall not have a positive bias to the gate concurrently with a negative potential on the anode. Devices should not be tested with a constant current source for forward and reverse blocking voltages such that the applied voltage exceeds the ratings.

T. 25-15

ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Peak Forward or Reverse Blocking Current (Rated V <sub>DRM</sub> or V <sub>RRM</sub> , gate open) T <sub>C</sub> = 105°C	I <sub>DRM</sub> , I <sub>RRM</sub>	—	0.2	2	mA
Gate Trigger Current (Continuous dc) (V <sub>D</sub> = 7 Vdc, R <sub>L</sub> = 100 ohms)	I <sub>GT</sub>	—	10	50	mA <sub>dc</sub>
Gate Trigger Voltage (Continuous dc) (V <sub>D</sub> = 7 Vdc, R <sub>L</sub> = 100 ohms)	V <sub>GT</sub>	—	0.8	1.5	Volts
Holding Current (V <sub>D</sub> = 7 Vdc, gate open)	I <sub>H</sub>	3	15	—	mA
Forward On Voltage (I <sub>TM</sub> = 5 A, PW ≤ 1 ms, Duty Cycle ≤ 1%)	V <sub>TM</sub>	—	—	2.6	Volts
Dynamic Forward On Voltage (0.5 μs after 50% pt, I <sub>G</sub> = 200 mA, V <sub>D</sub> = Rated V <sub>DRM</sub> , I <sub>F</sub> (pulse) = 30 Amps)	V <sub>TM</sub>	—	15	25	Volts
Turn-On Time (t <sub>d</sub> + t <sub>r</sub> ) (I <sub>G</sub> = 200 mA, V <sub>D</sub> = Rated V <sub>DRM</sub> ) (I <sub>TM</sub> = 30 Amps peak) (I <sub>TM</sub> = 100 Amps peak)	t <sub>on</sub>	—	200 400	—	ns
Turn-On Time Variation (T <sub>C</sub> = +25°C to +105°C and -65°C to +25°C, I <sub>TM</sub> = 30 A)	t <sub>on</sub>	—	±500	—	ns
Pulse Turn-Off Time (I <sub>F</sub> (pulse) = 30 Amps, I <sub>reverse</sub> = 0) (Inductive charging circuit)	t <sub>rec</sub>	—	15	—	μs
Forward Voltage Application Rate (Linear Rate of Rise) (V <sub>D</sub> = Rated V <sub>DRM</sub> , gate open, T <sub>C</sub> = 105°C)	dv/dt	50	—	—	V/μs
Thermal Resistance (Junction to Case)	θ <sub>JC</sub>	—	—	4	°C/W